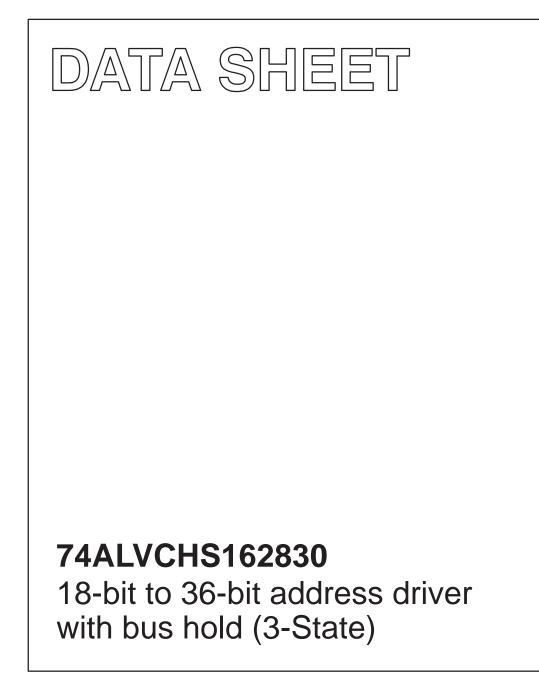
## INTEGRATED CIRCUITS



Product data

File under Integrated Circuits — ICL03

2001 Sep 07

PHILIPS





#### FEATURES

- Output ports have equivalent 26 Ω series resistors, so no external resistors are required
- Diodes on inputs clamp overshoot
- ESD classification testing is done to JEDEC Standard JESD22. Protection exceeds 2000 V HBM per method A114.
- Latch-up testing is done to JEDEC Standard JESD78, which exceeds 100 mA.
- Bus hold on data inputs eliminates the need for external pullup/pulldown resistors
- Packaged in thin very small-outline package (TVSOP) 0.4 mm pitch
- Optimized for use with PCK953 in SDRAM module applications
- Balanced ±12 mA output drive
- Low noise, low skew

### DESCRIPTION

The ALVCHS162830 address driver is designed for 2.3 V to 3.6 V  $V_{CC}$  operation.

Diodes to V<sub>CC</sub> have been added on the inputs to clamp overshoot.

The bus hold feature retains the inputs' last state whenever the input bus goes to high impedance. This prevents floating inputs and eliminates the need for pull up or pull down resistors.

The outputs, which are designed to sink up to 12 mA, include equivalent 26  $\Omega$  series resistors to reduce overshoot and undershoot.

To ensure the high-impedance state during power up or power down, the output-enable ( $\overline{\text{OE}}$ ) input should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The 74ALVCHS162830 is characterized for operation from –40 to +85  $^\circ\text{C}.$ 

### **FUNCTION TABLE**

Inputs			Outp	uts
OE1	OE2	А	1Yn	2Yn
L	Н	Н	Н	Z
L	Н	L	L	Z
Н	L	Н	Z	Н
Н	L	L	Z	L
L	L	Н	Н	Н
L	L	L	L	L
Н	Н	Х	Z	Z

#### **PIN CONFIGURATION**

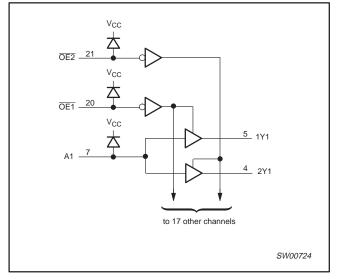
	TOP VIEW	
2Y2 1		80 1Y3
1Y2 2		79 2Y3
GND 3		78 GND
2Y1 4		77 1Y4
1Y1 5		76 2Y4
V <sub>CC</sub> 6	-	75 V <sub>CC</sub>
A1 7	-	74 1Y5
A2 8		73 2Y5
GND 9		72 GND
A3 10		71 1Y6
A4 11	-	70 2Y6
GND 12		69 GND
A5 13		68 1Y7
A6 14		67 2Y7
V <sub>CC</sub> 15		66 V <sub>CC</sub>
A7 [16		65 1Y8
A8 17		64 2Y8
GND 18		63 GND
A9 19		62 1Y9
0E1 20		61 2Y9
0E2 21		60 1Y10
A10 22	-	<sup>59</sup> 2Y10
GND 23		58 GND
A11 24	-	57 1Y11
A12 25		56 2Y11
V <sub>CC</sub> 26		55 V <sub>CC</sub>
A13 27	-	54 1Y12
A14 28	-	53 2Y12
GND 29		52 GND
A15 30		51 1Y13
A16 31		50 2Y13
GND 32		49 GND
A17 33		48 1Y14
A18 34		47 2Y14
V <sub>CC</sub> 35		46 V <sub>CC</sub>
2Y18 36		45 1Y15
1Y18 37		44 2Y15
GND 38		43 GND
2Y17 39		42 1Y16
1Y17 40		41 2Y16
		SW00723

### **ORDERING INFORMATION**

PACKAGES	TEMPERATURE RANGE	ORDER CODE	DWG NUMBER
80-pin plastic thin very small outline (TVSOP)	–40 to +85 °C	74ALVCHS162830DGB	SOT647-1

## 74ALVCHS162830

## LOGIC DIAGRAM (POSITIVE LOGIC)



## PIN DESCRIPTION

PIN(S)	SYMBOL	FUNCTION
6, 15, 26, 35, 46, 55, 66, 75	V <sub>CC</sub>	Supply voltage
7, 8, 10, 11, 13, 14, 16, 17, 19, 22, 24, 25, 27, 28, 30, 31, 33, 34	An	Inputs
1, 2, 4, 5, 36, 37, 39, 40, 41, 42, 44, 45, 47, 48, 50, 51, 53, 54, 56, 57, 59, 60, 61, 62, 64, 65, 67, 68, 70, 71, 73, 74, 76, 77, 79, 80	1Yn, 2Yn	Outputs
20, 21	OE1, OE2	Output enable
3, 9, 12, 18, 23, 29, 32, 38, 43, 49, 52, 58, 63, 69, 72, 78	GND	Ground

## **ABSOLUTE MAXIMUM RATINGS**

Over recommended operating free-air temperature range (unless otherwise noted).<sup>1</sup>

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT	
V <sub>CC</sub>	Supply voltage range		-0.5 to +4.6	V	
VI	Input voltage range	See Note 2	-0.5 to +4.6	V	
V <sub>O</sub>	Output voltage range	See Notes 2 and 3	–0.5 to V <sub>CC</sub> +0.5	V	
I <sub>IK</sub>	Input clamp current	V <sub>1</sub> < 0	-50	mA	
I <sub>OK</sub>	Output clamp current	V <sub>O</sub> < 0	-50	mA	
Ι <sub>Ο</sub>	Continuous output current		± 50	mA	
$I_{\mathrm{CC}}, I_{\mathrm{GND}}$	Continuous current through each $V_{CC}$ or GND		±100	mA	
$\Theta_{JA}$	Package thermal impedance	See Note 4	106	°C/W	
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C	

NOTES:

 Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

3. This value is limited to 4.6 V maximum.

4. The package thermal impedance is calculated in accordance with JESD 51.

## 74ALVCHS162830

Product data

## **RECOMMENDED OPERATING CONDITIONS**

All unused control inputs of the device must be held at  $V_{\mbox{CC}}$  or GND to ensure proper device operation.

evuno:	DADAMETER	CONDITIONS	LIN	<b>/</b> ITS		
SYMBOL	PARAMETER	CONDITIONS	MIN	MAX		
V <sub>CC</sub>	Supply voltage		2.3	3.6	V	
M		$V_{CC}$ = 2.3 V to 2.7 V	1.7		V	
VIH	V <sub>IH</sub> High-level input voltage	$V_{CC}$ = 2.7 V to 3.6 V	2		7 <sup>v</sup>	
M		$V_{CC}$ = 2.3 V to 2.7 V		0.7	V	
V <sub>IL</sub>	Low-level input voltage	$V_{CC}$ = 2.7 V to 3.6 V		0.8		
VI	Input voltage		0	V <sub>CC</sub>	V	
Vo	Output voltage		0	V <sub>CC</sub>	V	
		V <sub>CC</sub> = 2.3 V		-6		
I <sub>OH</sub>	High-level output current	V <sub>CC</sub> = 2.7 V		-8	mA	
		$V_{CC} = 3 V$		-12	1	
		V <sub>CC</sub> = 2.3 V		6		
I <sub>OL</sub> Low-level output curre	Low-level output current	V <sub>CC</sub> = 2.7 V		8	mA	
		$V_{CC} = 3 V$		12	1	
$\Delta t/\Delta v$	Input transition rise or fall rate			10	ns/V	
T <sub>amb</sub>	Operating free-air temperature		-40	+85	°C	

## 74ALVCHS162830

## **ELECTRICAL CHARACTERISTICS**

Over recommended operating free-air temperature range (unless otherwise noted).

					LIMITS			
SYMBOL	PARAMETER	TEST CONDI	TIONS	V <sub>cc</sub>	MIN	TYP <sup>1</sup>	MAX	
N		l <sub>l</sub> = -18 mA	I <sub>I</sub> = -18 mA I <sub>I</sub> = 18 mA				-1.2	
VIK		l <sub>l</sub> = 18 mA					V <sub>CC</sub> +1.2	
		I <sub>OH</sub> = −100 μA		2.3 V to 3.6 V	V <sub>CC</sub> -0.2			
		I <sub>OH</sub> = -4 mA, V <sub>IH</sub> = 1.7 V		2.3 V	1.9			1
V <sub>OH</sub>		- 0 mA	V <sub>IH</sub> = 1.7 V	2.3 V	1.7			V
011		I <sub>OH</sub> = -6 mA	V <sub>IH</sub> = 2 V	3 V	2.4			1
		I <sub>OH</sub> = -8 mA, V <sub>IH</sub> = 2 V	•	2.7 V	2			1
		I <sub>OH</sub> = –12 mA, V <sub>IH</sub> = 2 V		3 V	2			1
		I <sub>OL</sub> = 100 μA		2.3 V to 3.6 V			0.2	
		I <sub>OL</sub> = 4 mA, V <sub>IL</sub> = 0.7 V		2.3 V			0.4	
V <sub>OL</sub>		V <sub>IL</sub> = 0.7 V	2.3 V			0.55		
0L		$I_{OL} = 6 \text{ mA}$	V <sub>IL</sub> = 0.8 V	3 V			0.55	1
		I <sub>OL</sub> = 8 mA, V <sub>IL</sub> = 0.8 V		2.7 V			0.6	1
		I <sub>OL</sub> = 12 mA, V <sub>IL</sub> = 0.8 V		3 V			0.8	1
I <sub>I</sub>		$V_I = V_{CC}$ or GND		3.6 V			±5	μA
		V <sub>I</sub> = 0.7 V		2.3 V	45			$\square$
		V <sub>I</sub> = 1.7 V		2.3 V	-45		1	1
I <sub>I(hold)</sub>		V <sub>I</sub> = 0.8 V		3 V	75		1	μA
		V <sub>I</sub> = 2 V		3 V	-75		1	1
		$V_{I} = 0$ to 3.6 $V^{2}$		3.6 V			±500	1
I <sub>OZ</sub>		$V_{O} = V_{CC}$ or GND		3.6 V			±10	μA
I <sub>CC</sub>		$V_I = V_{CC}$ or GND, $I_O = 0$		3.6 V			40	μA
$\Delta I_{CC}$		One input at $V_{CC} - 0.6 V$ , Other inputs at $V_{CC}$ or GND		3 V to 3.6 V			750	μΑ
0	Control inputs			2.0.1/		3.5		
Ci	Data inputs	$V_{I} = V_{CC} \text{ or GND}$		3.3 V		7.64	1	— pF
Co	Outputs	$V_{O} = V_{CC}$ or GND		3.3 V		3.12	1	pF

NOTES:

1. All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_{amb} = 25^{\circ}\text{C}$ . 2. This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

#### Product data

## 74ALVCHS162830

### SWITCHING CHARACTERISTICS

Over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 and 2).

PARAMETER	FROM	то	V <sub>CC</sub> = 2.5	$V \pm 0.2 V$	V <sub>CC</sub> =	2.7 V	V <sub>CC</sub> = 3.3	V $\pm$ 0.3 V	UNIT
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	UNIT
t <sub>pd</sub>	A	Y	1.2	3.8		4	1.7	3.5	ns
t <sub>en</sub>	ŌĒ	Y	1	5.7		5.7	1	4.8	ns
t <sub>dis</sub>	ŌĒ	Y	1	4.9		5.4	1.7	5.2	ns
t <sub>sk(o)</sub> 1	Output skew	-	-	-	-	-	-	500	ps

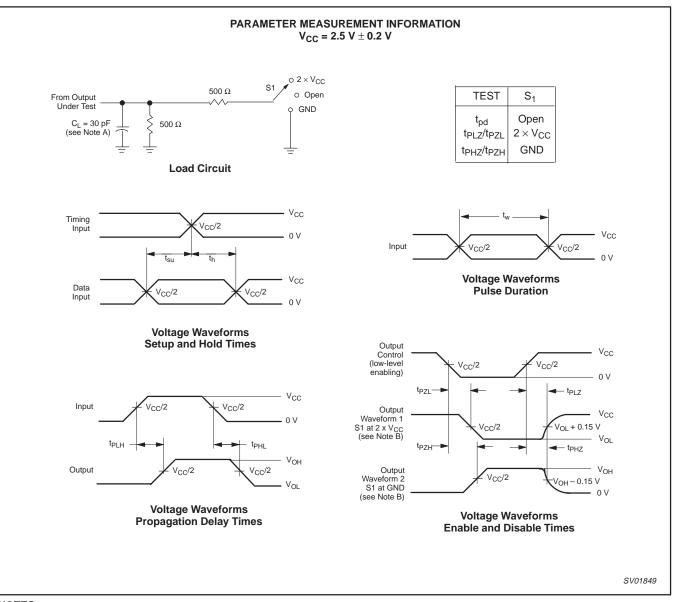
NOTE:

1. Output skew between any 2 outputs of same part switching in the same direction.

## OPERATING CHARACTERISTICS, $T_{amb} = 25^{\circ}C$

SYMBOL		METER	TEST CONDITIONS	$V_{CC}$ = 2.5 V $\pm$ 0.2 V	$V_{CC}$ = 3.3 V $\pm$ 0.3 V	UNIT
STMBOL			TEST CONDITIONS	TYP	TYP	UNIT
	Power dissipation	All outputs enabled	C <sub>1</sub> = 0, f = 10 MHz	49	53	ρF
C <sub>pd</sub>	capacitance per driver	All outputs disabled	$C_L = 0, T = T0 MHZ$	6	7.5	рг





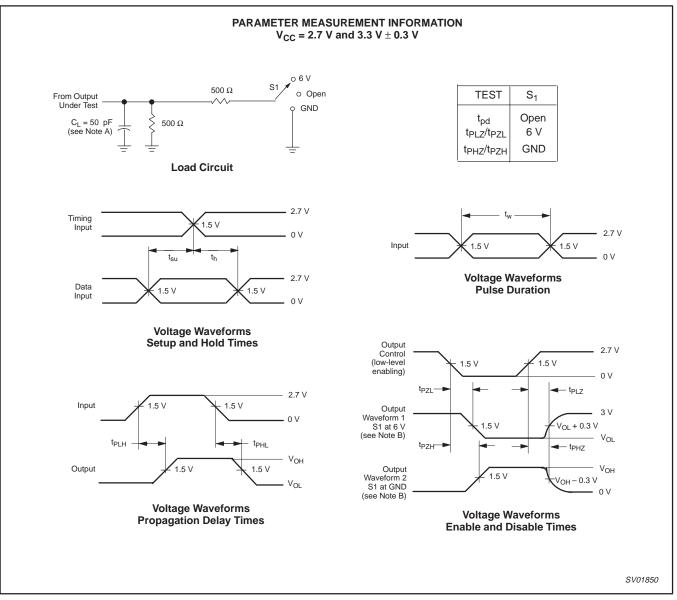
### NOTES:

A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_0 = 50 \Omega$ ,  $t_f \leq 2$  ns,  $t_f \leq 2$  ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

#### Figure 1. Load circuit and voltage waveforms





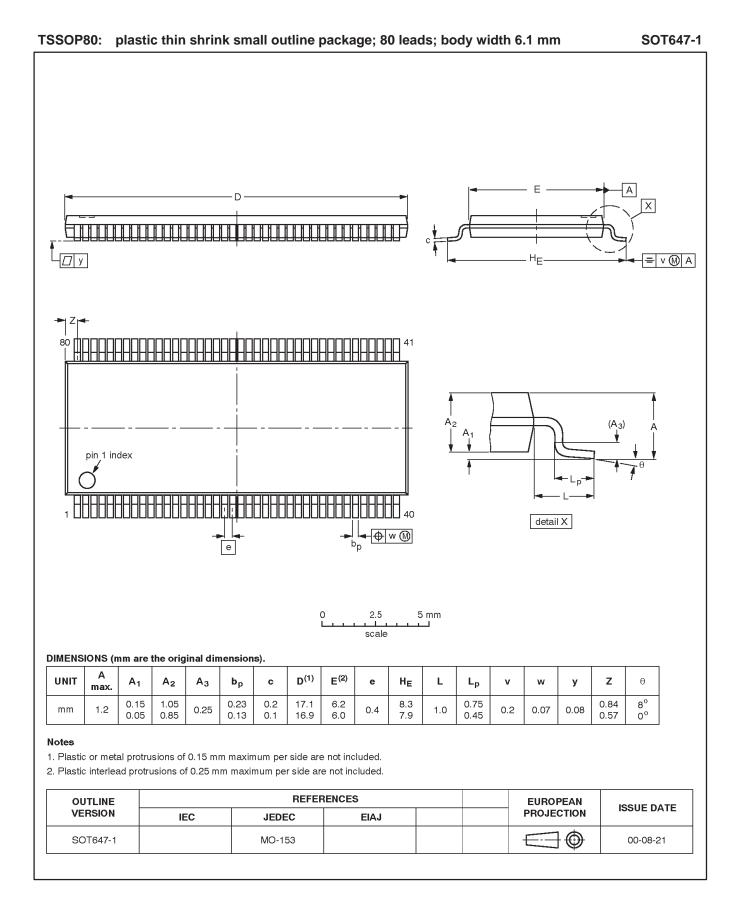
## NOTES:

A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  2.5 ns, t<sub>f</sub>  $\leq$  2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E.  $t_{\text{PLZ}}$  and  $t_{\text{PHZ}}$  are the same as  $t_{\text{dis}}.$
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

#### Figure 2. Load circuit and voltage waveforms

## 74ALVCHS162830



## 74ALVCHS162830

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Data sheet status <sup>[1]</sup>	Product status <sup>[2]</sup>	Definitions
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